GSR2401

2.4 GHz BT/IOT Front End Modul

Product Description

The GSR2401 is a high performance, fully integrated RF front end module (FEM) designed for Bluetooth, Zigbee applications. The device provides all the functionality of a fully matched power amplifier (PA), low-noise amplifier (LNA), and two single-pole, triple-throw (SP3T) switches.

The GSR2401 provides a complete 2.4 GHz WLAN RF solution from the output of the transceiver to the antenna, and from the antenna to the input of the transceiver. The LNA increases the receive sensitivity of embedded solutions to improve range. The low current bypass mode decrease the power consumption when working in a good signal environment. The GSR2401 also includes digital enable control pins for power ramp on/off control.

The RF blocks operate over a wide supply voltage range from 3.0 V to 5.2 V.

The device is provided in a compact, 16-pin3.0 x3.0 mm Quad Flat No-Lead (QFN) package. Pin map is shown in Figure 1. A functional block diagram is shown in Figure 2.

Pin Map

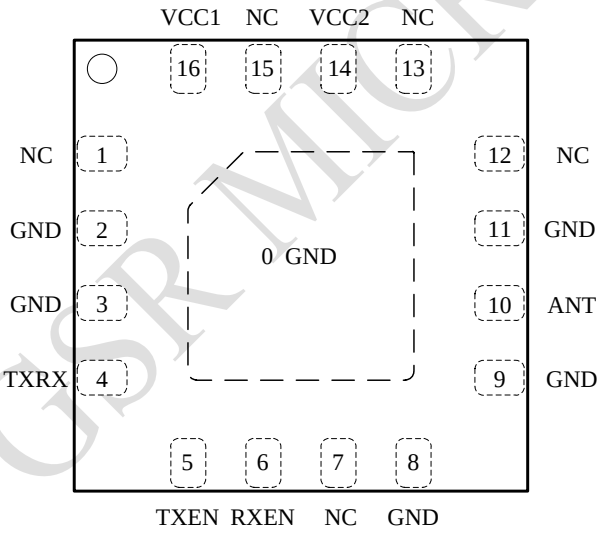


Figure 1 GSR2401 Pin Map (Top View)

Functional Block Diagram

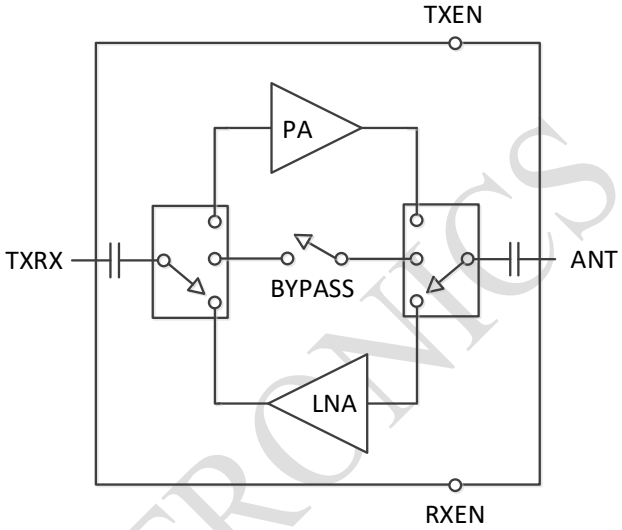


Figure 2 Block Diagram

Key Features

- Saturated output power: 23 dBm@3.3 V
- Integrated LNA (1.5 dB noise figure)
- Single ended transmit/receive interface
- Input and output matched to 50 ohm
- Wide supply range (3.0 V to 5.2 V)
- No external bias resistor is required
- High Impedance Control Pin

Applications

- Range extender
- Wireless sound and audio systems
- Custom 2.4 GHz radio systems
- Wireless sensor networks
- Zigbee smart power
- Zigbee extended range devices

Pin Description

Pin	Name	Description
0	GND	Ground
1	NC	Not connected or Ground
2	GND	Ground
3	GND	Ground
4	TXRX	RF signal to/from the transceiver
5	TXEN	Control voltage for the PA
6	RXEN	Control voltage for the LNA
7	NC	Not connected or Ground
8	GND	Ground
9	GND	Ground
10	ANT	Antenna
11	GND	Ground
12	NC	Not connected or Ground
13	NC	Not connected or Ground
14	VCC2	Supply voltage
15	GND	Not connected
16	VCC1	Supply voltage

Absolute Maximum Ratings

Parameter	Conditions	Rating
DC Supply Voltage		-0.5 to +6 V
Control Voltage (TXEN, RXEN,)		-0.5 to +3.6 V
Storage Temperature		-40 to 150 ℃
Junction Temperature		Max 150 ℃
RF Input Power at TXRX, Transmit Mode	ANT connect 50 Ω Load	+20 dBm
RF Input Power at ANT, Receive Mode	TXRX connect 50 Ω Load	+20 dBm

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Recommended Operating Conditions

Parameter	Min	Typ	Max	Units
Operating Frequency	2400	-	2500	MHz
DC Supply Voltage	3.0	3.3	5.2	V
Control Voltage – High	1.2	-	3.6	V
Control Voltage – Low	0	-	0.4	V
Operating temperature	-40	25	125	℃

Logic Truth Table

Mode	TXEN	RXEN
Transmit Mode	High	Low
Receive Mode	Low	High
Bypass Mode	Low	Low
Bypass Mode	High	High

Electrical Specifications

Parameter	Conditions	Min	Typ	Max	Units
Transmit Mode	Unless otherwise noted: VCC1, VCC2=3.3 V, Temp=+25ºC, TXEN=High, RXEN=Low				
Saturated output power	Pin = 10 dBm		23.0		dBm
Small signal gain	Pin = -20 dBm		25		dB
Out of Band Gain	f = 5000 ~ 6000 MHz		-12		dB
TXRX Port Return Loss			20		dB
ANT Port Return Loss			6		dB
Quiescent Current	RF OFF		30		mA
Operating Current	Pout=20 dBm, CW		97		mA
	Pout=14 dBm, CW		58		mA
Second Harmonics	Pout= 20 dBm		-12		dBm/MHz
Third Harmonics	Pout= 20 dBm		-27		dBm/MHz
Switching Time	From 50% of TXEN edge to 90% of final RF output power		200		nS
Stability	CW, Pin= 0 dBm, 0.1 GHz to 20 GHz, load VSWR= 10:1	All non-harmonically related outputs< -42 dBm/MHz			
Ruggedness	Rated power = 20 dBm, load VSWR 10:1	No damage			
Receive Mode	Unless otherwise noted: VCC1, VCC2=3.3 V, Temp=+25ºC, TXEN=Low, RXEN= High				
Noise Figure			1.5		dB

Gain			14		dB
Out of Band Gain	f = 5000 ~ 6000 MHz		-15		dB
RX Port Return Loss			8		dB
ANT Port Return Loss			9		dB
Quiescent Current			15		mA
Input P1dB			-4		dBm
Switching Time	From 50% of RXEN edge to 90% of final RF output power		200		nS
Bypass Mode	Unless otherwise noted: VCC1, VCC2= 3.3 V, Temp=+25ºC, TXEN=0 V, RXEN=0 V				
Insertion Loss			-5.5		dB
$IP_{0.1dB}$	Input 0.1 dB Compression Point		23		dBm
TXRX Port Return Loss			10		dB
ANT Port Return Loss			10		dB
Quiescent Current	RF OFF（Sleep supply current）		40		uA

Application Schematic

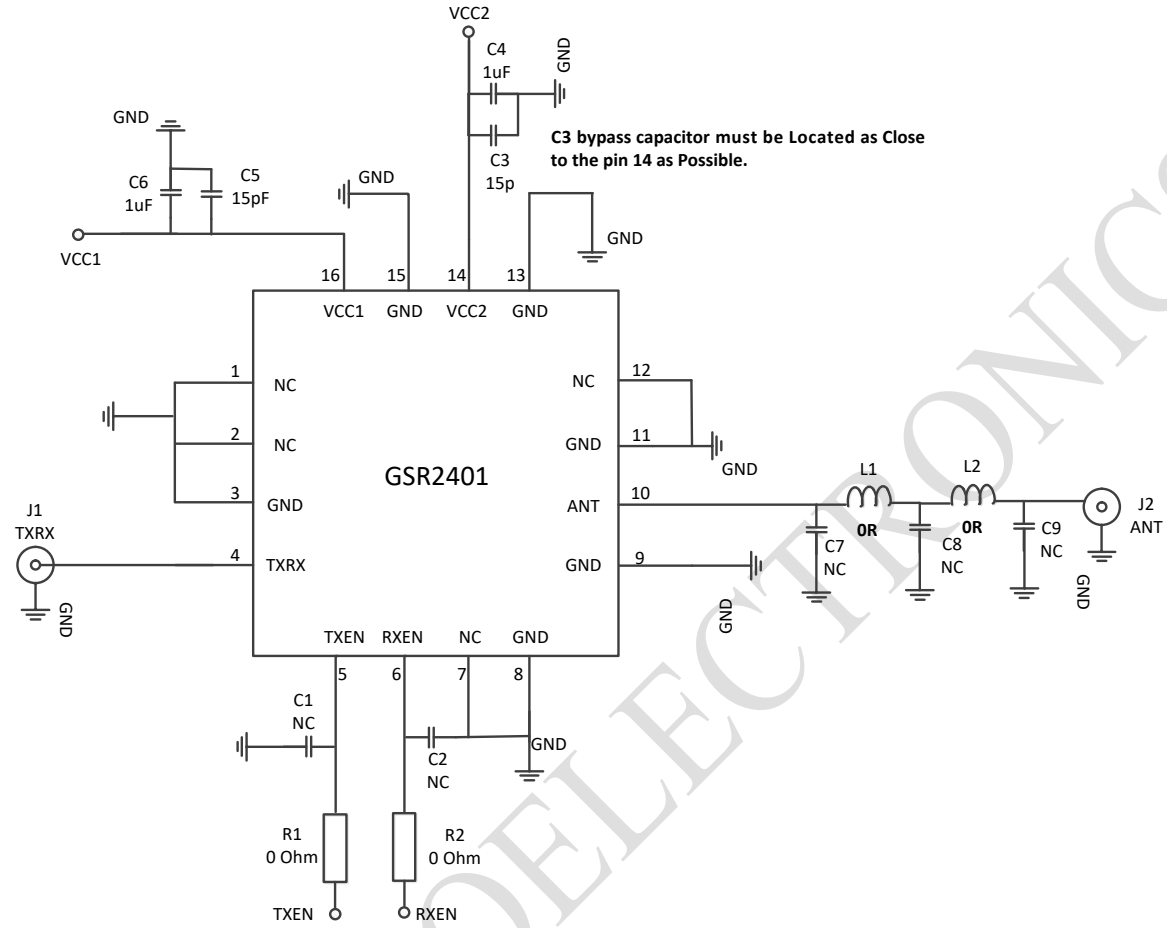


Figure 3 GSR2401 Application Schematic

Note:

1. PCB layout refer to GSR2401 Application Note for Details

Part Marking

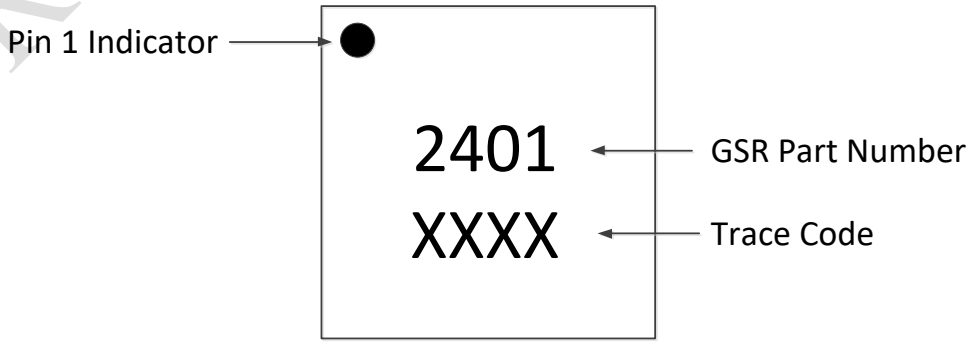
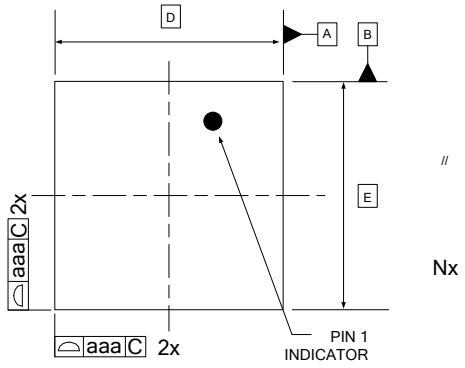
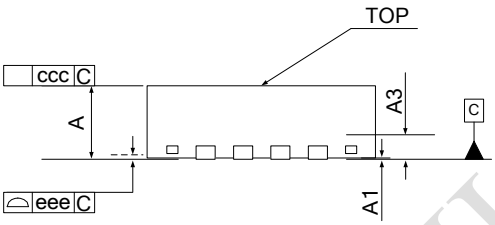


Figure 4 GSR2401 Marking

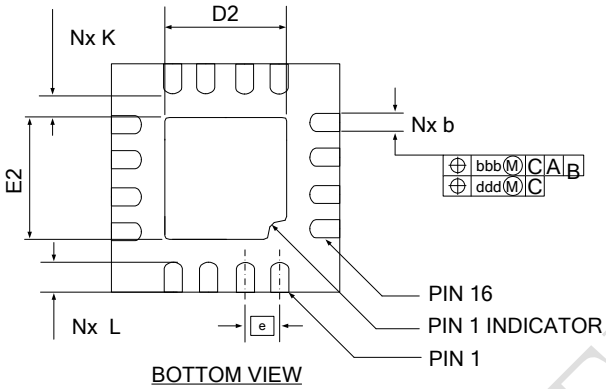
Package Outline



TOP VIEW



SIDE VIEW



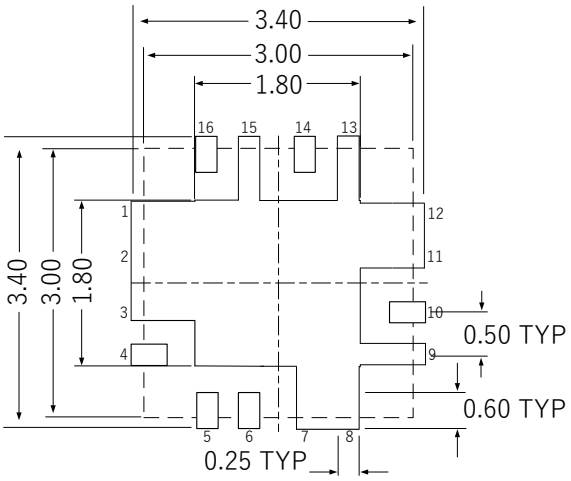
BOTTOM VIEW

NOTE:
1. Dimensioning and tolerancing conform to ASME Y14.5-2009.
2. All dimensions are in millimeters.
3. N is the total number of terminals.
4. The location of the marked terminal #1 identifier is within the hatched area.
5. ND and NE refer to the number of terminals on each D and E side respectively.
6. Dimension b applies to the metalized terminal and is measured between 0.15mm and 0.30mm from the terminal tip. If the terminal has a radius on the other end of it, dimension b should not be measured in that radius area.
7. Coplanarity applies to the terminals and all other bottom surface metallization.

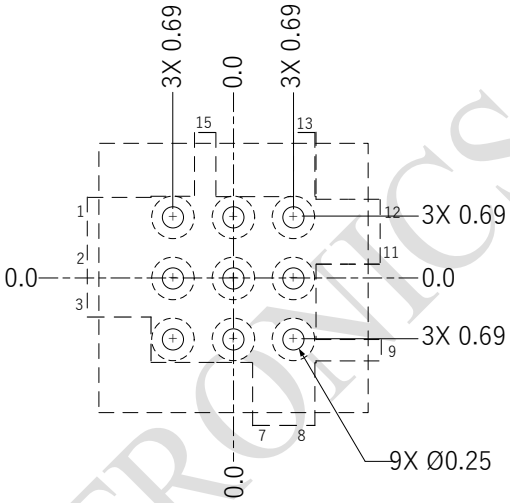
Dimension Table				
	MINIMUM	NOMINAL	MAXIMUM	NOTE
A	0.7	0.75	0.80	
b	0.2	0.25	0.3	
D		3.0		
E		3.0		
e		0.5		
D2	1.6	1.70	1.80	
E2	1.6	1.70	1.80	
K	0.2			
L	0.3	0.4	0.5	
N		16		
aaa	0.05			
bbb	0.10			
ccc	0.10			
ddd	0.05			
eee	0.08			
N	16	3		
ND	4	5		
NE	4	5		

Figure 4 GSR2401Package Outline

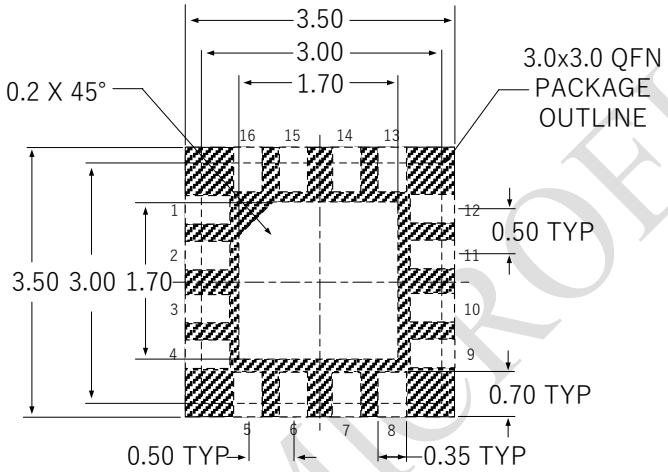
PCB Layout Print



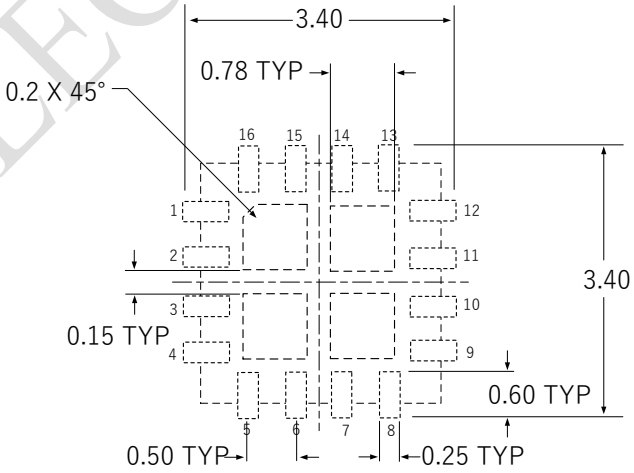
BOARD METAL



VIA PATTERN



SOLDER MASK
PATTERN



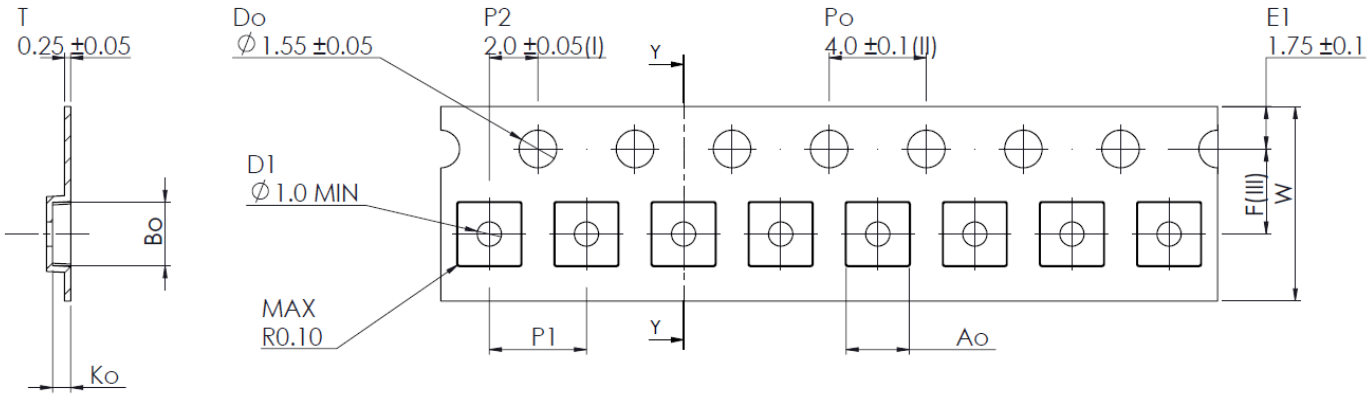
STENCIL PATTERN

Notes:

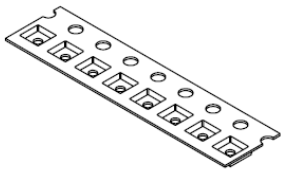
1. All dimensions are in millimeters.
2. Unless specified, dimensions are symmetrical about center lines.

Figure 6 GSR2401 Recommended PCB Footprint

Tape and Reel Information



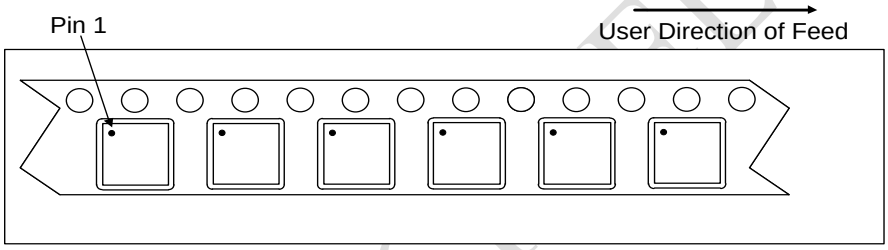
SECTION Y-Y

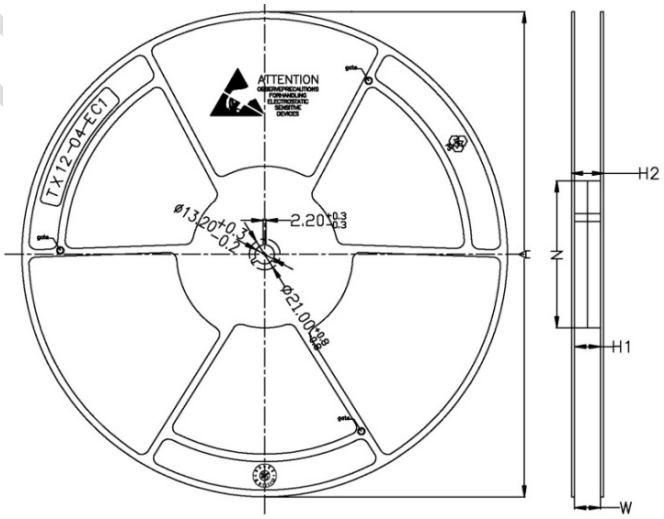


Ao	2.60	+/- 0.1
Bo	2.60	+/- 0.1
Ko	0.75	+/- 0.1
F	3.50	+/- 0.05
P1	4.00	+/- 0.1
W	8.00	+0.3/- 0.1

(I) Measured from centreline of sprocket hole to centreline of pocket.
(II) Cumulative tolerance of 10 sprocket holes is ± 0.20 .
(III) Measured from centreline of sprocket hole to centreline of pocket.
(IV) Other material available.

ALL DIMENSIONS IN MILLIMETRES UNLESS OTHERWISE STATED.





PRODUCT SPECIFICATIONS					
TAPE WIDTH	øA	øN	H1	H2	W
12MM	330	100	12.4	16.6	12.4

Ordering Information

Part Number	Product Description	Package Type	Package Quantity
GSR2401	2.4GHz Front-End Module	13” tape and reel	3000 pcs / real

Handling Precautions

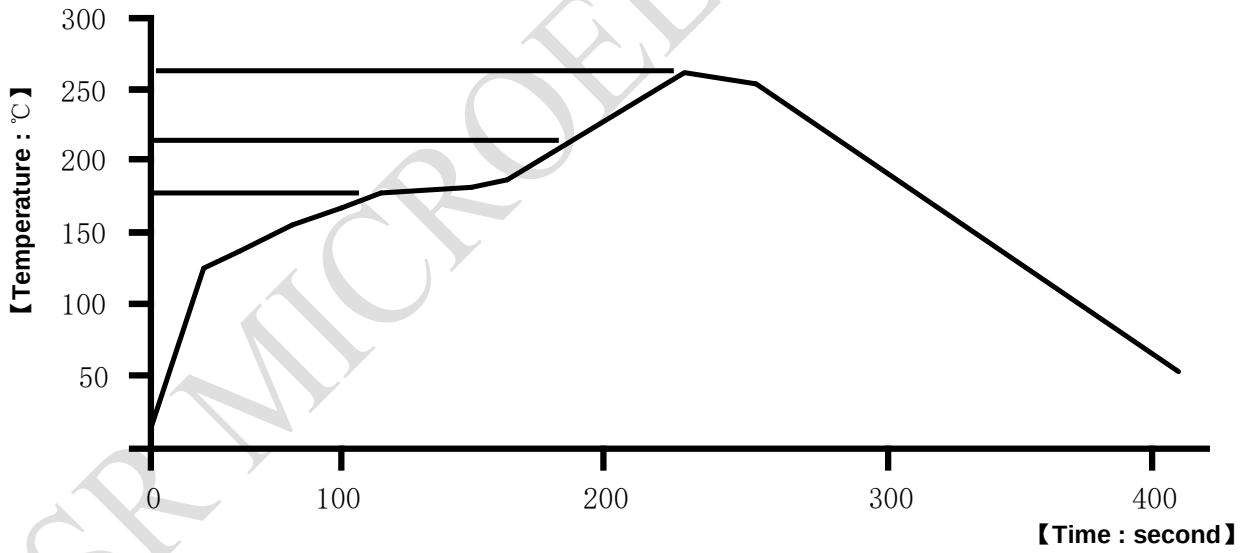
Test Model	ESD Rating	Value	Standard
Human Body Model (HBM)	Class 1C	≥ 1200 V	ESDA /JEDEC JS-001-2017
Charged Device Model (CDM)	Class C3	≥ 2000 V	ESDA /JEDEC JS-002-2018

Caution: Industry-standard ESD precautions should be used at all times.

MSL Rating

MSL Rating	Standard
3	JEDEC Standard IPC/JEDEC J-STD-020

Recommended IR Reflow Profile



Average ramp-up rate (200℃ to peak)	3°C/second max.
Preheat temperature (175±25)℃	60~120 secs
Temperature maintained above 217℃	60~150 secs
Time within 5℃ of actual peak temperature	30 seconds min.
Peak temperature range	(260±2)℃
Ramp down rate	6°C/second max.
Time 25℃ to peak temperature	8 minutes max.

Follow JEDEC spec J-STD-020D

RoHS Compliant

The product does not contain lead, mercury, cadmium, hexavalent chromium, poly brominated biphenyls (PBB) or poly brominated diphenyl ethers (PBDE), and are therefore considered RoHS compliant.

Version History

Revision	Description
A	Initial release

Contact Information

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